



# CryoBLM Beam test – first results

Christoph Kurfuerst  
CryoBLM Project  
BE-BI-BL CERN

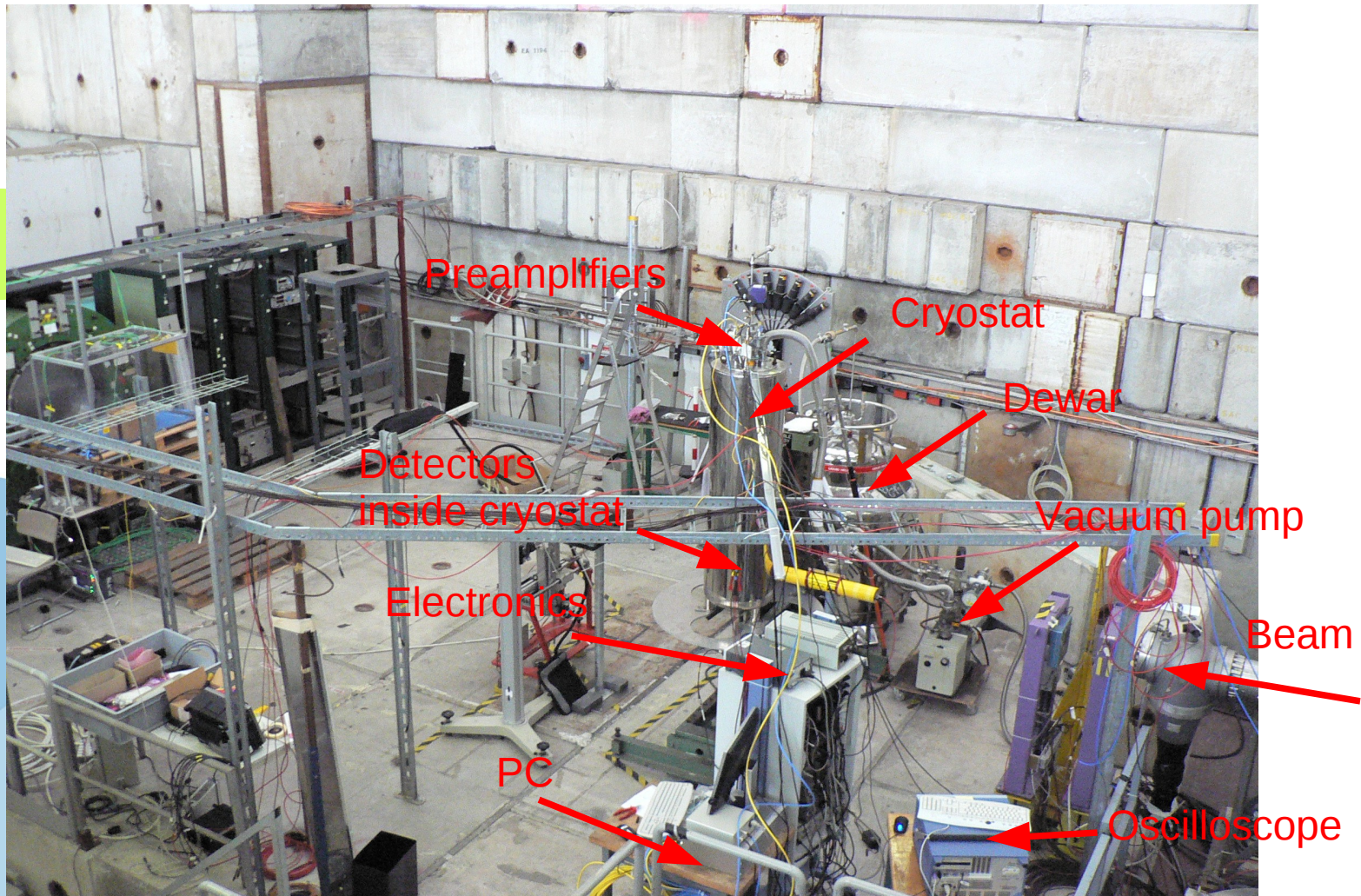


# Outline

- Measurement setup
- Beam characteristics
- Signal estimations
- Single particle mode
  - Trigger level discussion
  - Diamond results
  - Si results
  - Comparison
- DC measurements
  - LHe chamber results
  - Diamond results
  - Si results
- General comparison (estimation, single particle and DC)
- Open questions and future measurements



# Beam test area





# Semiconductors holder from Vladimir Eremin



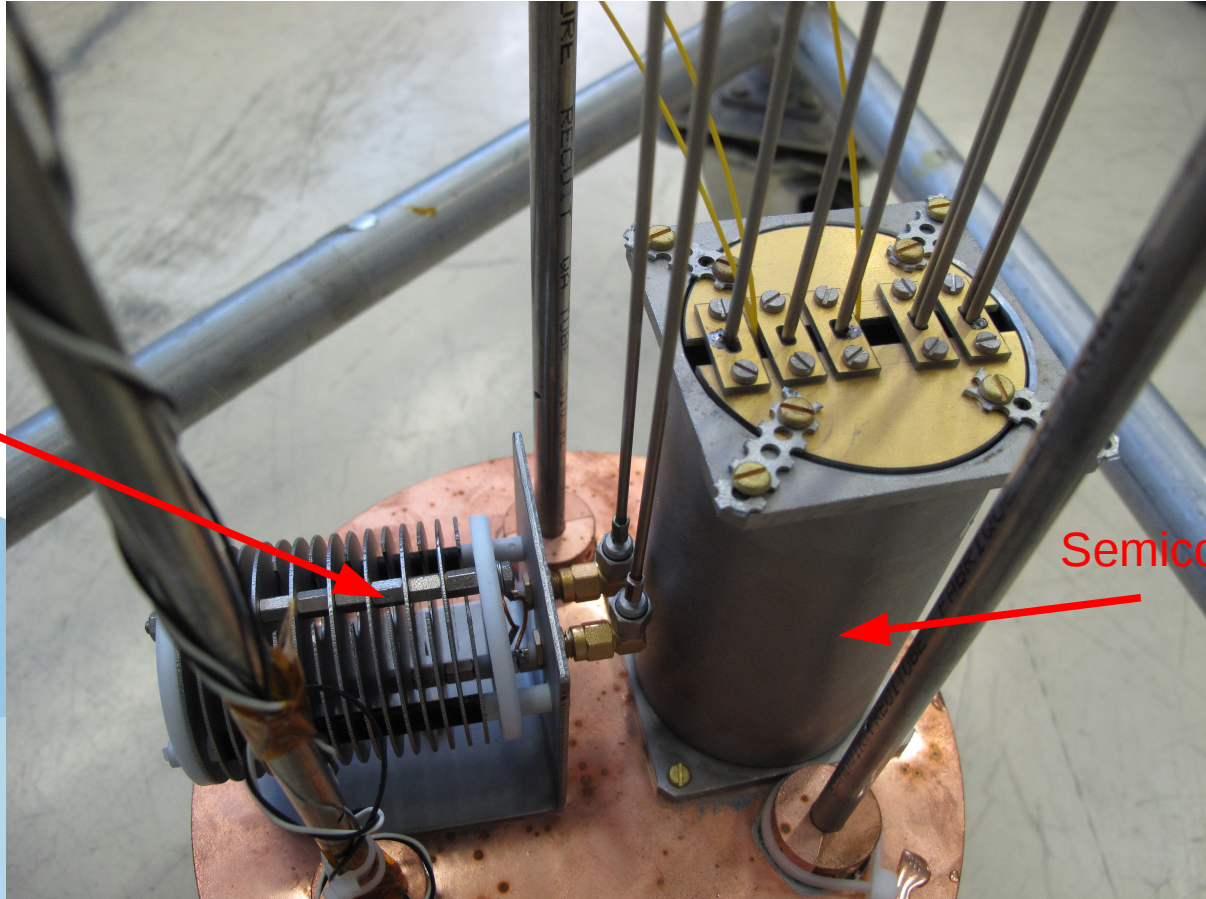
- 4 Silicon detectors
- 1 single crystal diamond (sCVD)



# Inside cryostat - detectors



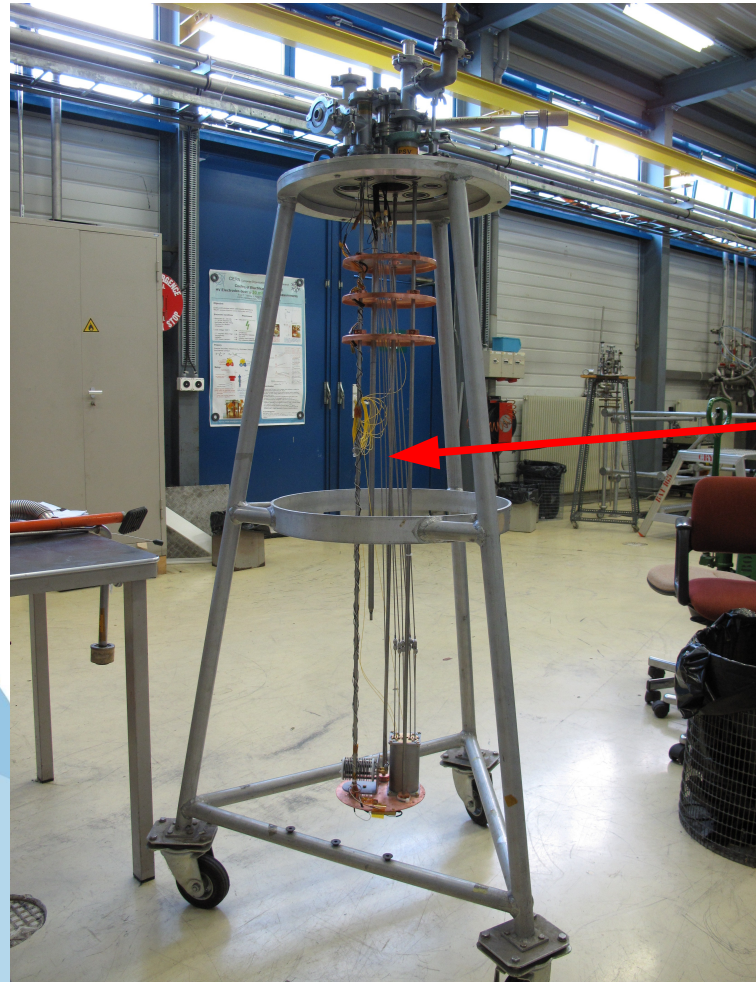
LHe chamber



Semiconductors



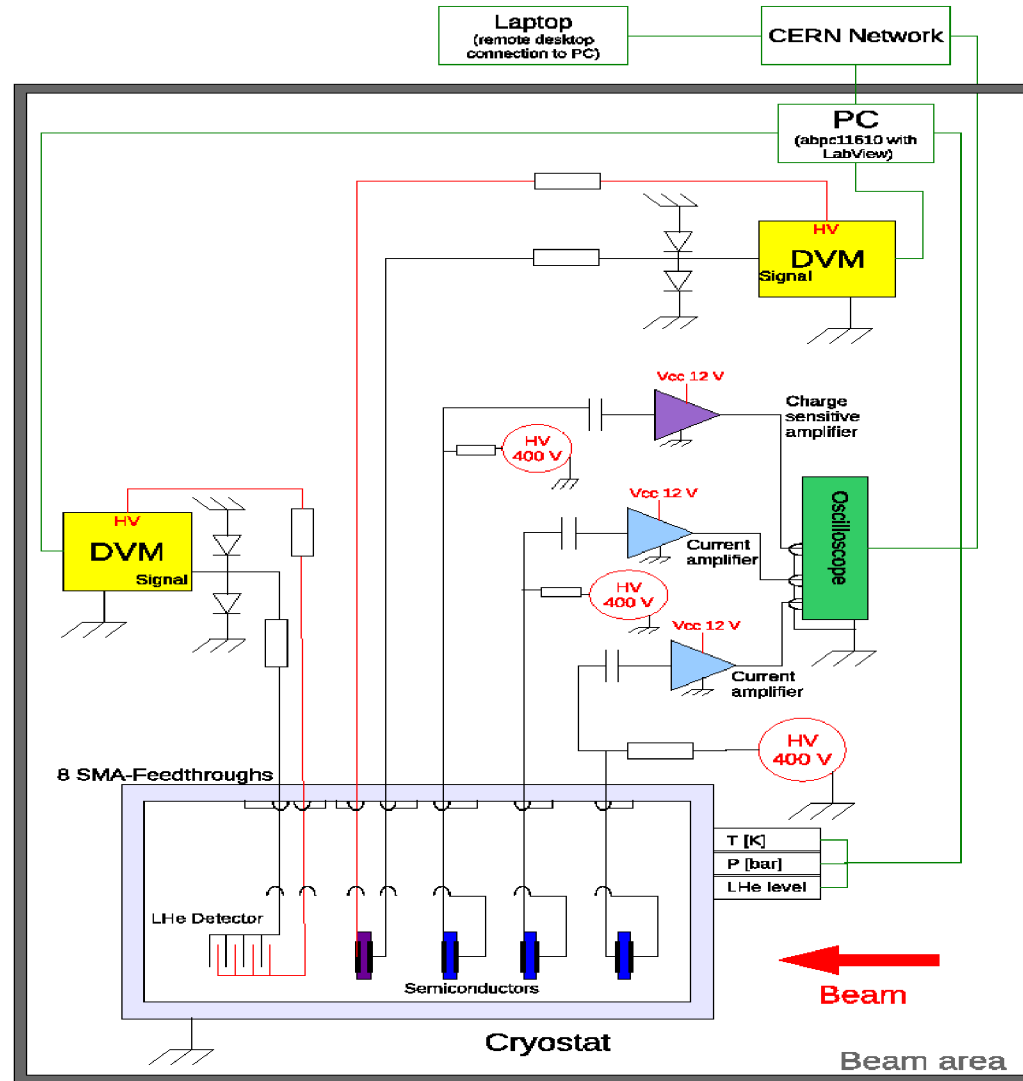
# Inside cryostat



Cable length  
between  
detectors and  
preamplifiers ~  
1.5 m



# Electronic setup general overview





## T9 Beam characteristics

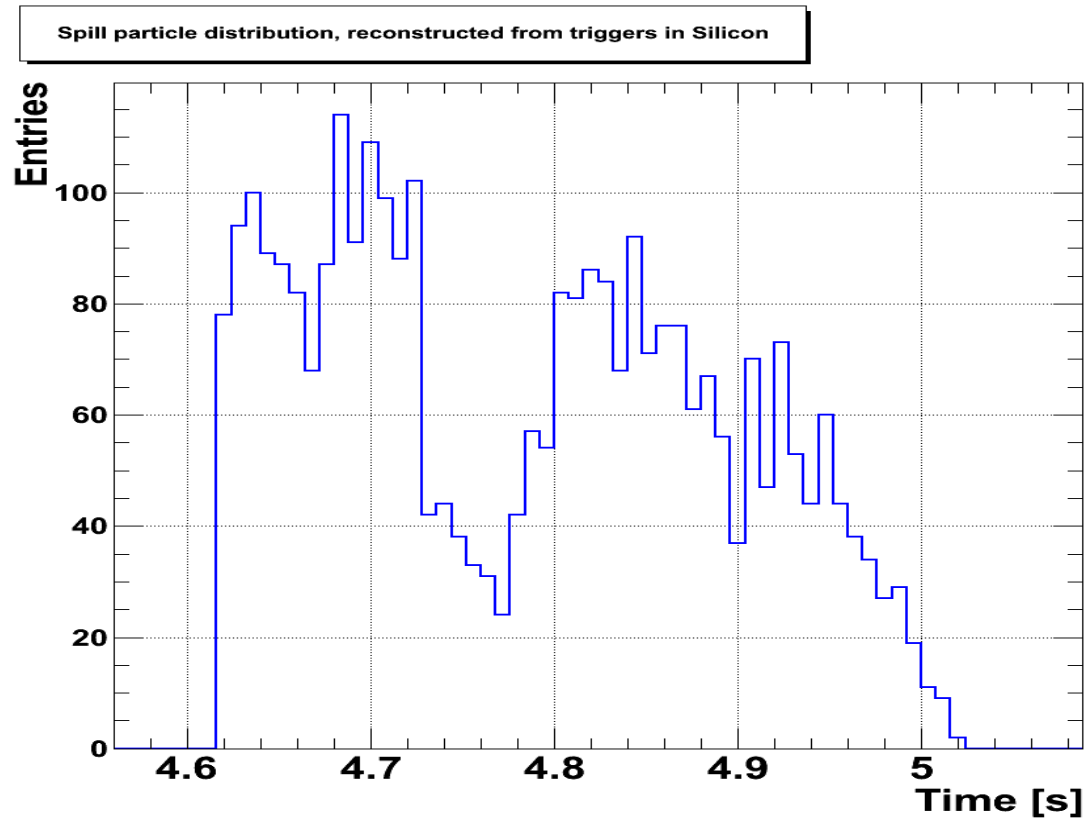
- Beam generated by directing PS beam onto target
- Particles consist of positive pions, kaons and protons (dominating)
- 10 GeV/c particles
- Beam intensity 350 000 particles/spill
- Size at focus about 1 cm<sup>2</sup>
- Spill duration of 400 ms (about 875 particles/ms)
- One spill every 45 s
- Practical advantages:
  - Close to cryolab
  - Enough space available for cryogenic setup
  - Fast beam stop and entering of radiation area possible





# Beam characteristics

## Spill shape



- Spill shape of one spill and about 3000 entries
- Adding more spills for better statistics and better average spill shape



# Signal Estimation

- Estimations done with:

- Stopping power of material  $P_{stop}$
- Density of material  $\rho$
- Electron-hole Pair creation energy  $E_{pair}$
- Dimensions of detector (active area  $A_{active}$  and length  $l$ )
- Beam characteristics (beam size  $A_{beam}$ , number of particles  $n_p$  and spill duration)

- Charge per particle:

- Liquid helium: **12.2 fC**
- sCVD: **3.79 fC**
- Si: **5.68 fC**

- Charge per spill:

- Liquid helium: **3.66 nC**
- sCVD: **182 pC**
- Si: **426 pC**

$$Q = \frac{P_{stop} \cdot \rho \cdot l}{E_{pair}}$$

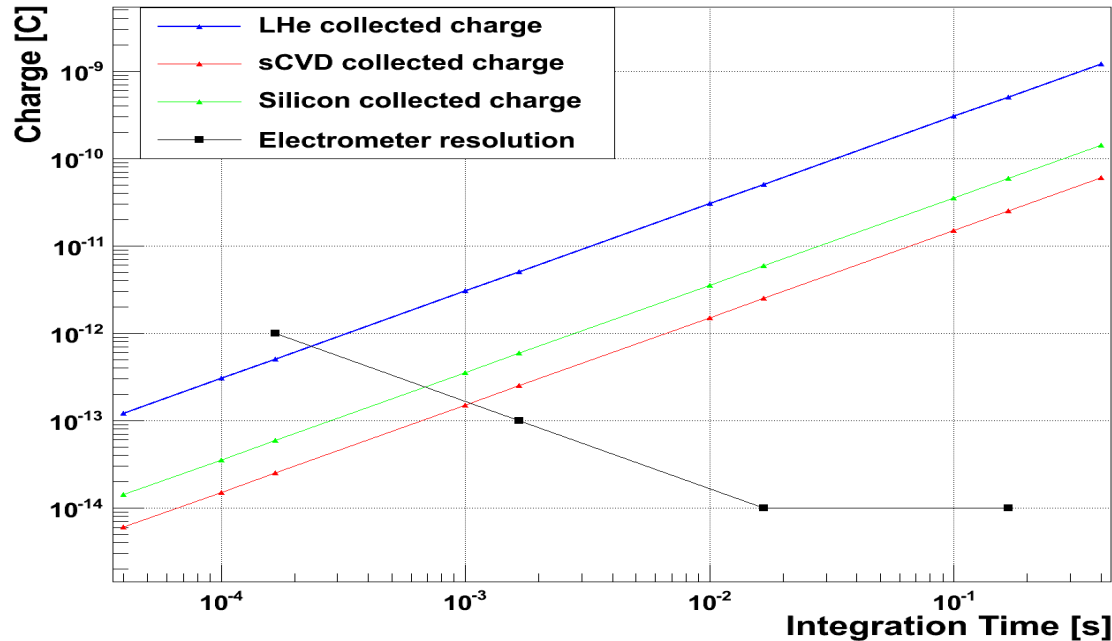
$$Q_{spill} = \frac{P_{stop} \cdot \rho \cdot l}{E_{pair}} \cdot n_p \cdot \frac{A_{active}}{A_{beam}}$$



# Signal Estimation

(Check done to see if signals measurable)

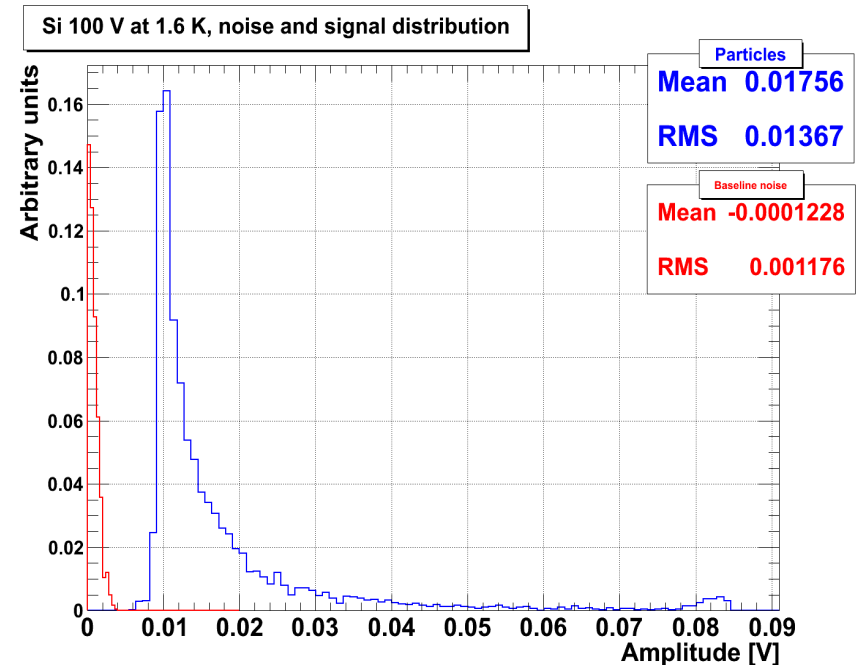
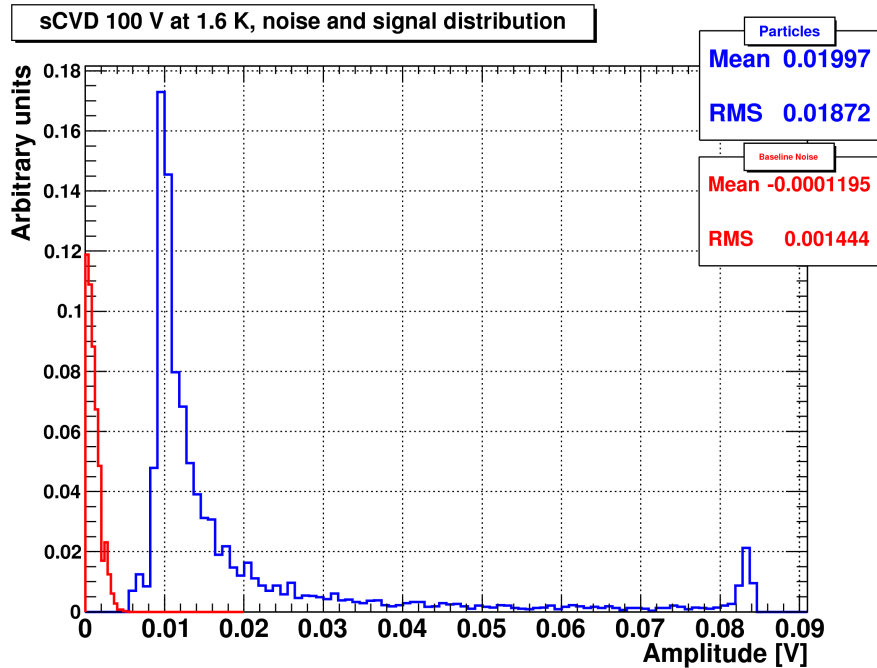
Estimated collected charge from T9 beam



- Estimated currents from particles:
  - LHe chamber: **9.14 nA**
  - sCVD: **454 pA**
  - Si: **1.07 nA**



# Noise and signal comparison through amplitude distribution



- 6 mV trigger (Trigger setting important)
- To compare with values from DiamondBLM:
  - Baseline noise RMS 0.4 mV
  - Particles mean: 16.9 mV



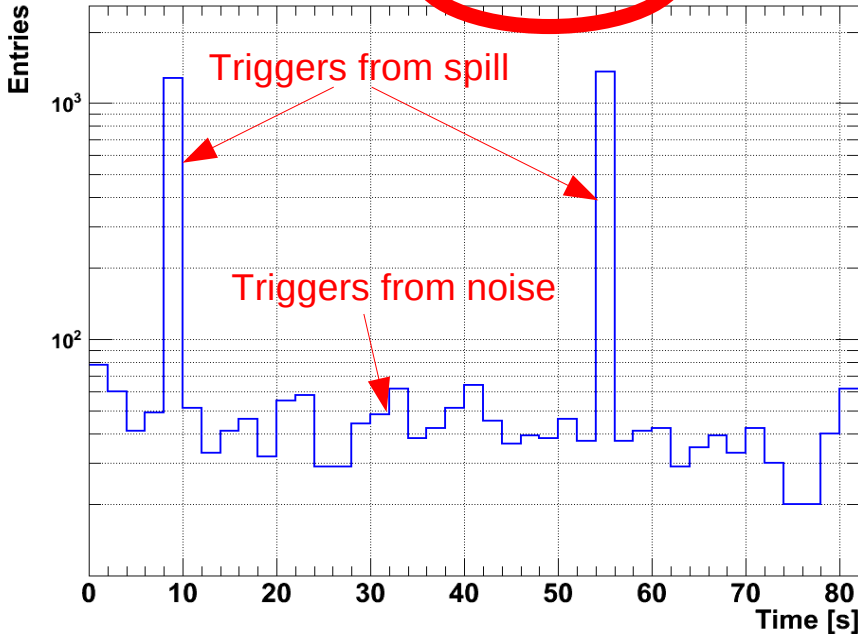
# Triggering method on oscilloscope for single particle detection

- Goal: detect all particles and no noise
- Noise level is slightly different (depending on vibrations from vacuum pump, heat of the amplifier,...) two strategies for trigger level:
  - 6 mV over all measurements to enable comparison (Downside: loss of pulses from particles)
  - Optimisation of trigger for each measurement (Downside: less comparable)
- Solutions for future:
  - Analysing only pulses inside the spill
  - Use additional external trigger next time

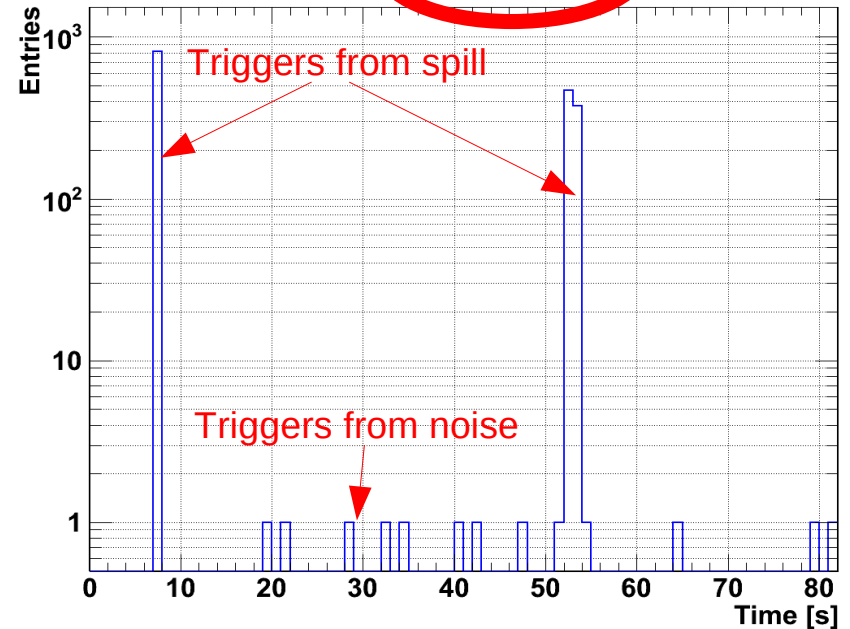


# Trigger level

sCVD 400 V at 3.4 K, trigger rate with 3.2 mV trigger level



sCVD 400 V at 3.4 K, trigger rate with 4 mV trigger level

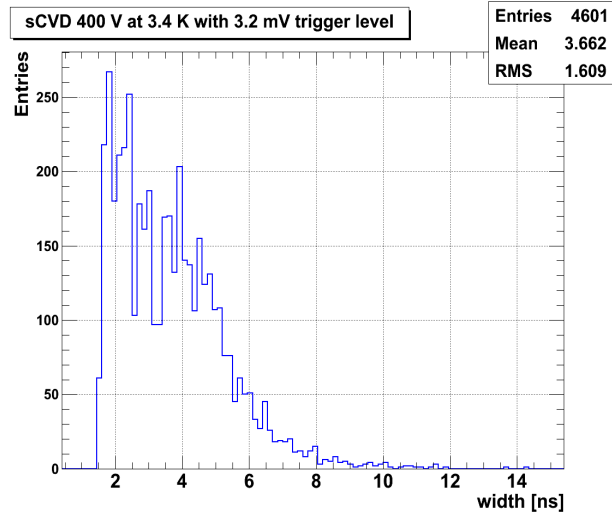
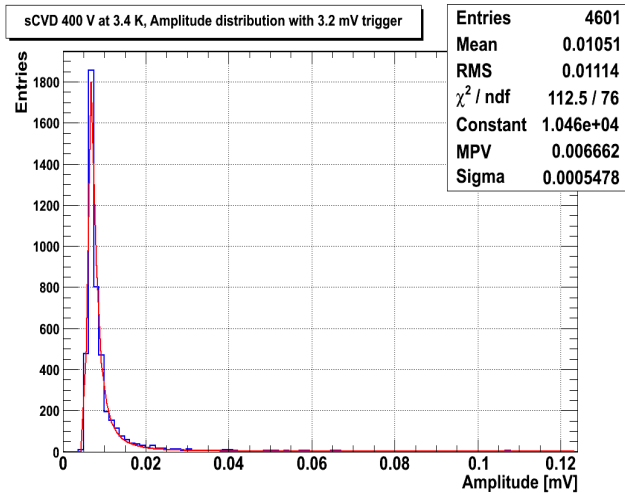


- With 3.2 mV trigger level about 30 % noise
- With 4 mV trigger lower noise rate, but also less particles detected from spill

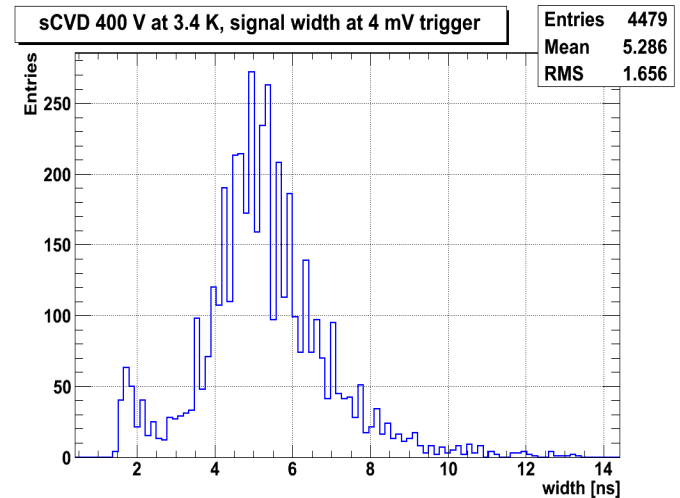
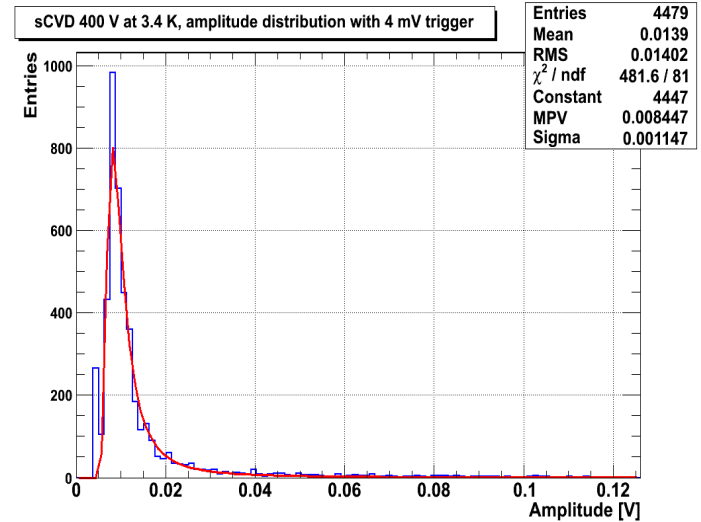


# Trigger level Comparison 3.2 mV and 4 mV level

## 3.2 mV trigger



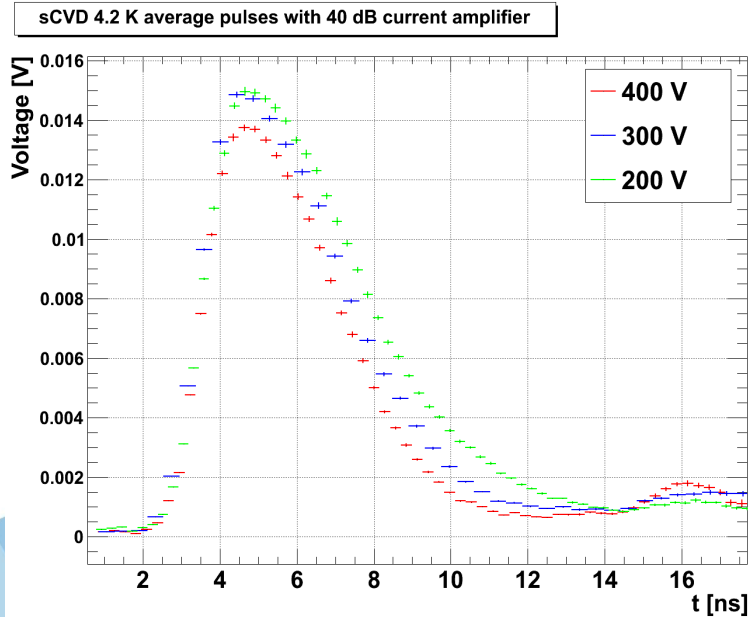
## 4 mV trigger



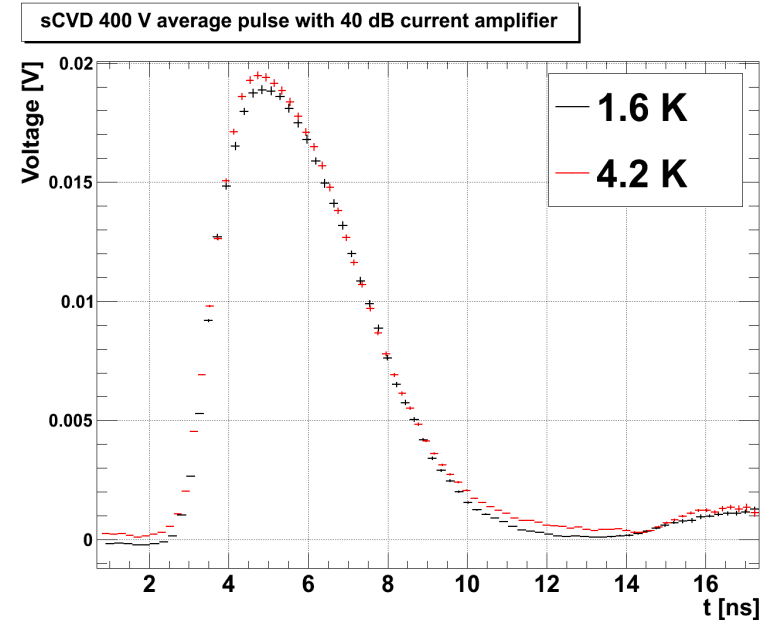


# Diamond results

## Single particle



- With 4 mV trigger



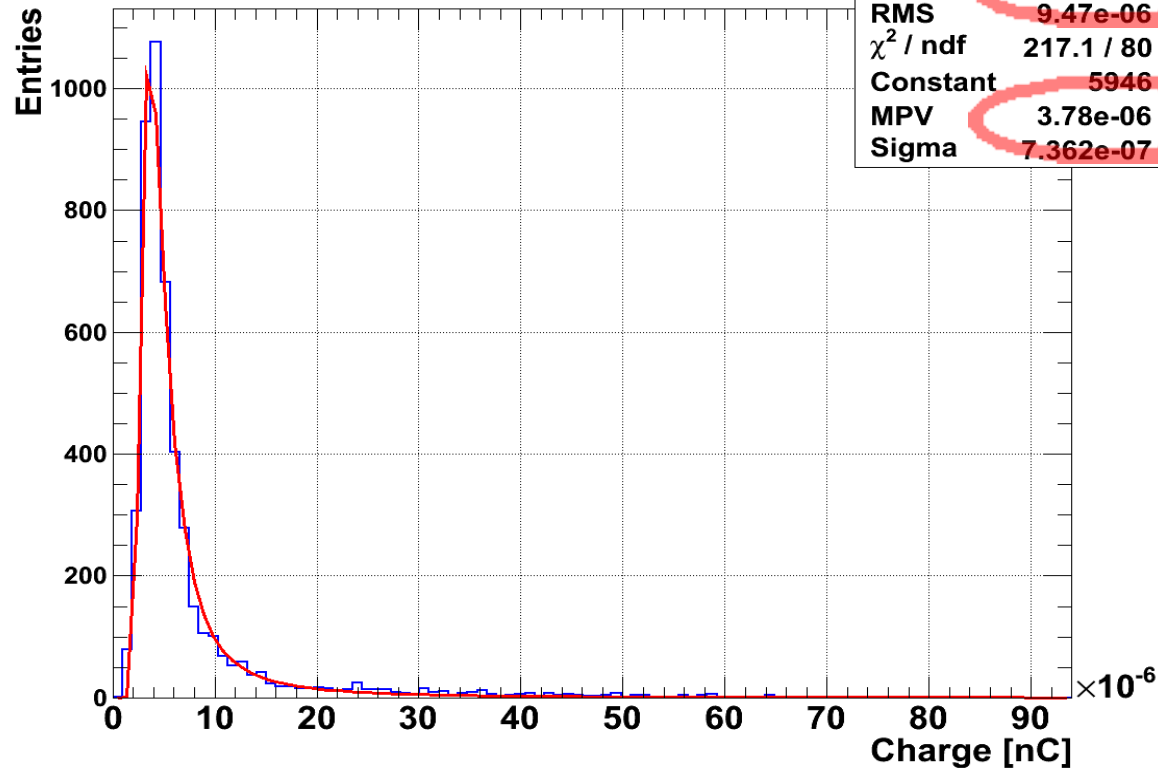
- With 6 mV trigger
- Only offset different
- Plot may be used as argument to make radiation hardness tests at 4.2 K only





# Diamond results 400 V Single particle detection

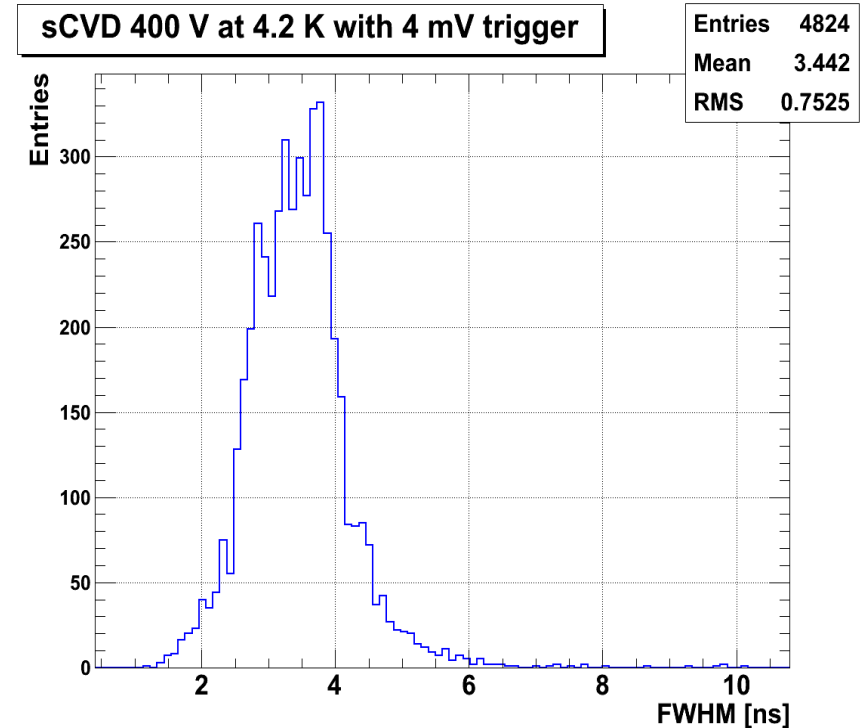
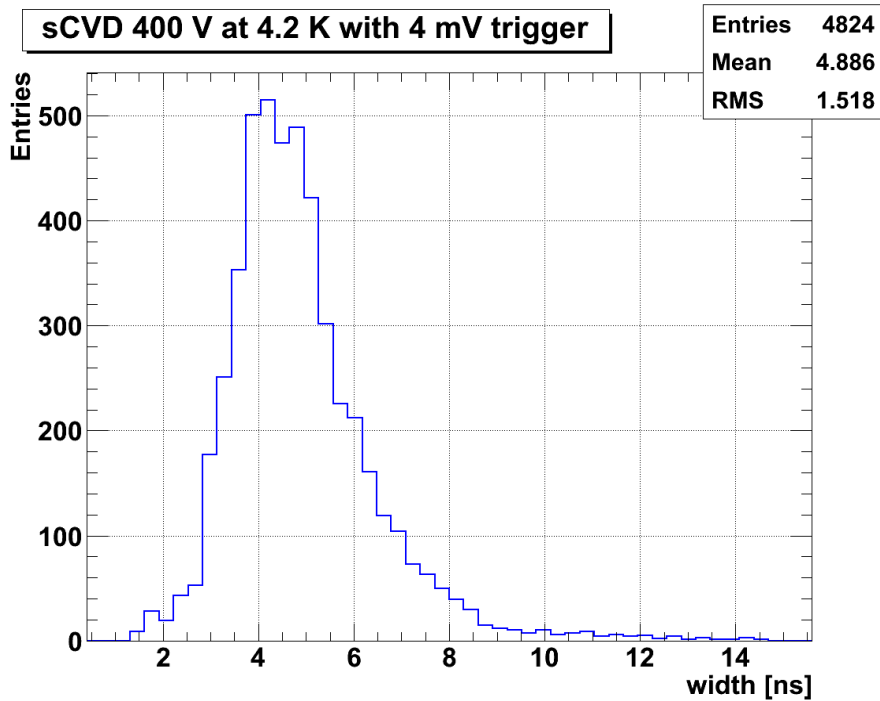
sCVD 400 V at 4.2 K, Charge distribution with 4 mV trigger



- Estimated: 3.79 fC



# Diamond results 400 V Single particle detection

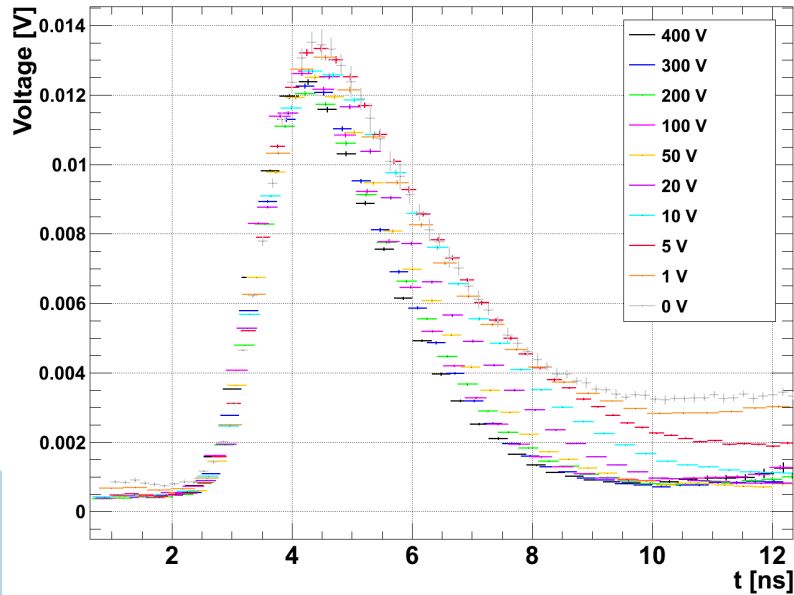




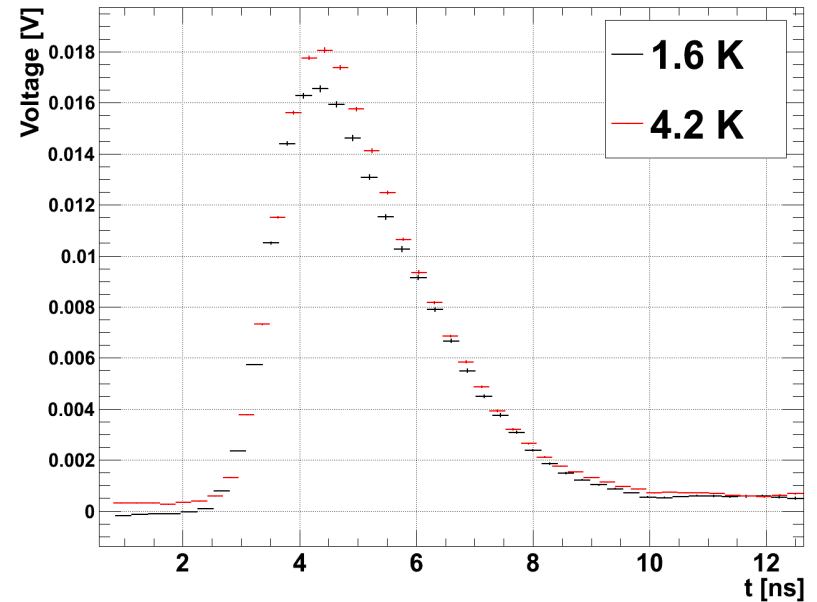
# Silicon results

## Single particle detection

Silicon average pulses at 4.2 K and 4 mV trigger



Si 100 V with 6 mV trigger, average pulses

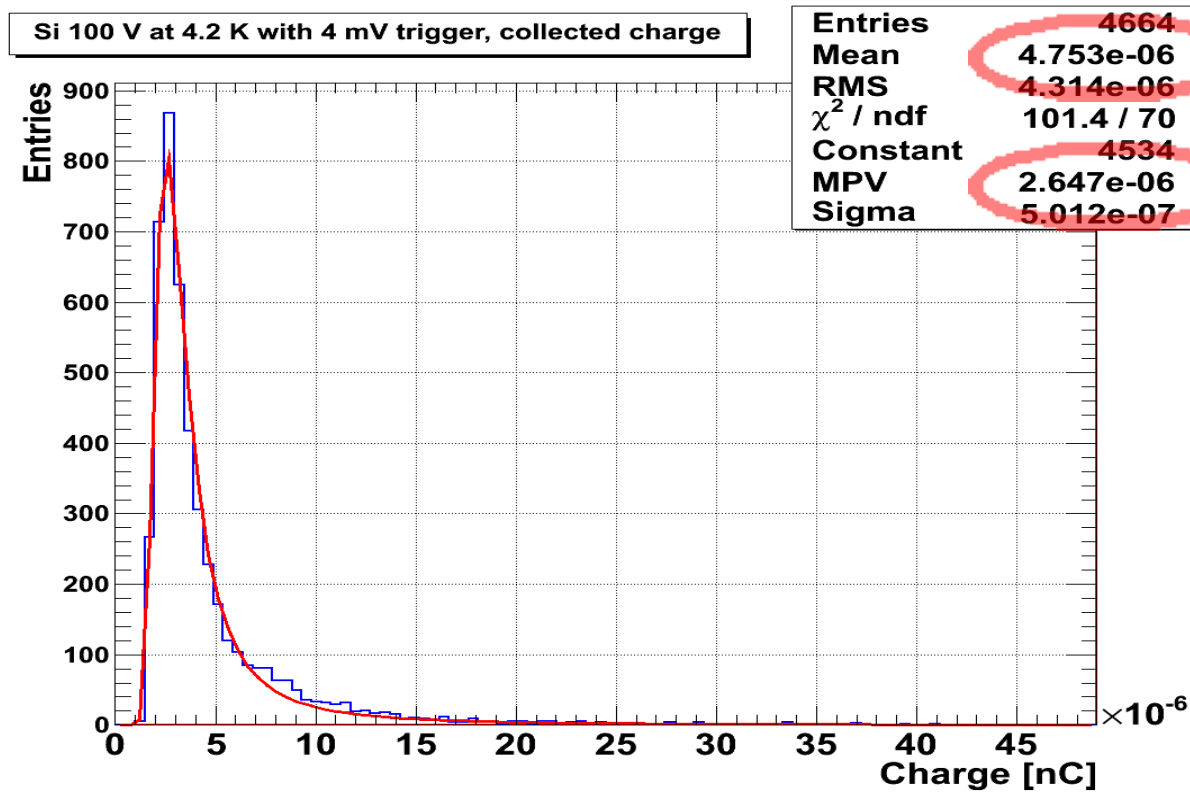


- Again no significant difference for Si between liquid and superfluid helium



# Silicon results

## Single particle detection



- Estimated: 5.68 fC

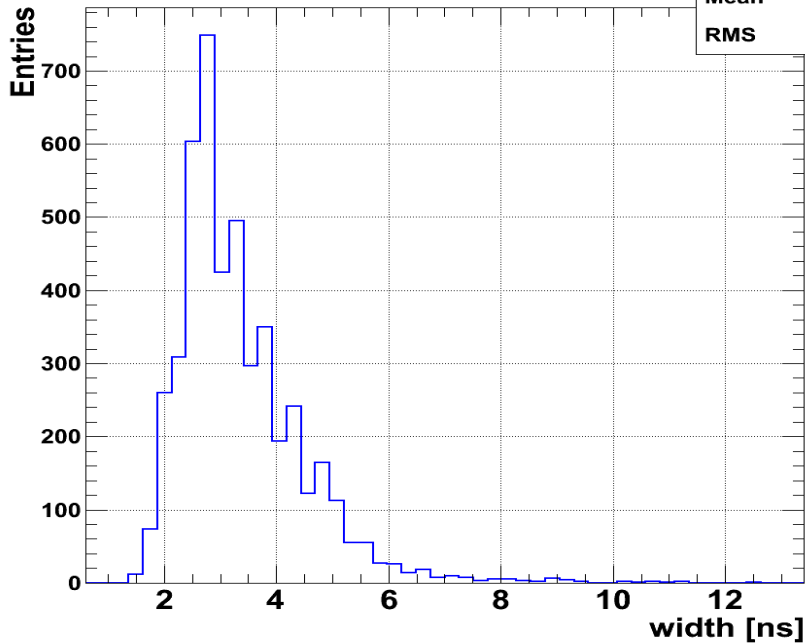


# Silicon results

## Single particle detection

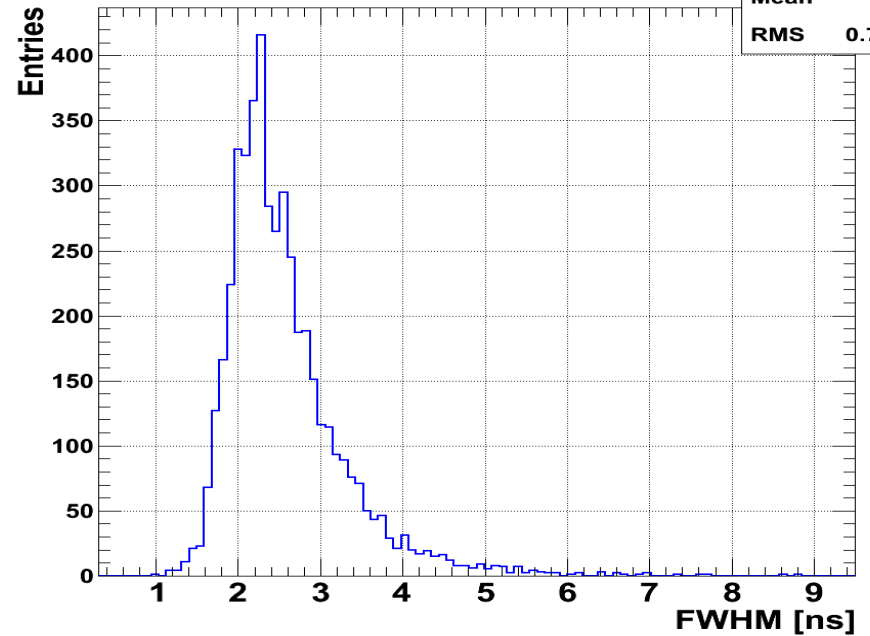
Si 100 V at 4.2 K with 4 mV trigger

Entries	4664
Mean	3.356
RMS	1.119



Si 100V at 4.2 K with 4 mV trigger

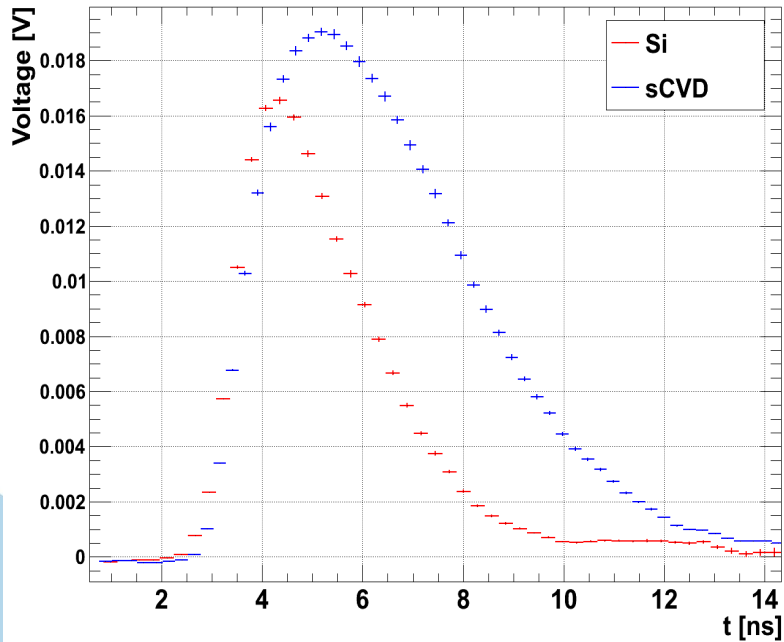
Entries	4664
Mean	2.57
RMS	0.7226



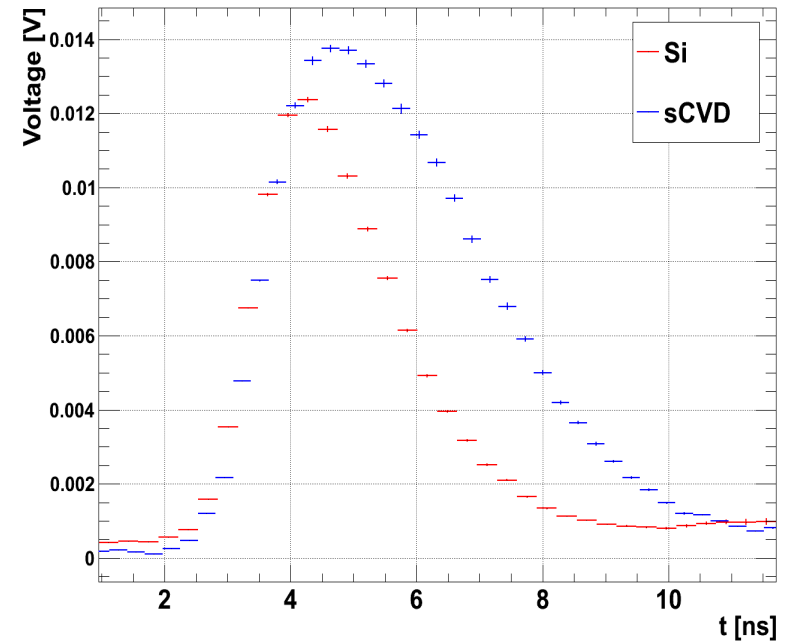


# Comparison sCVD and Si Single particle detection

Average pulse comparison at 100 V, 1.6 K and 6 mV trigger



Average pulse comparison at 400 V, 4.2 K and 4 mV trigger

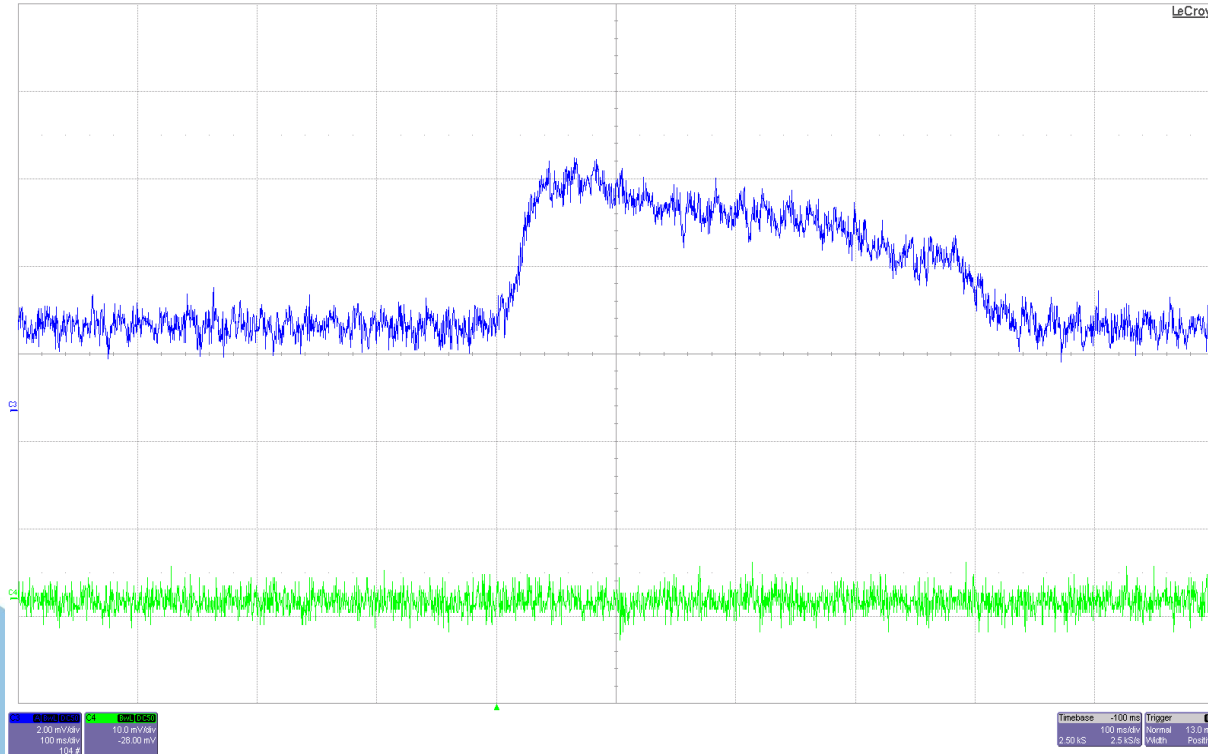


In average per particle more charge from sCVD compared to Si (contradiction with estimations and DC measurements)



# LHe ionisation chamber Fast read out

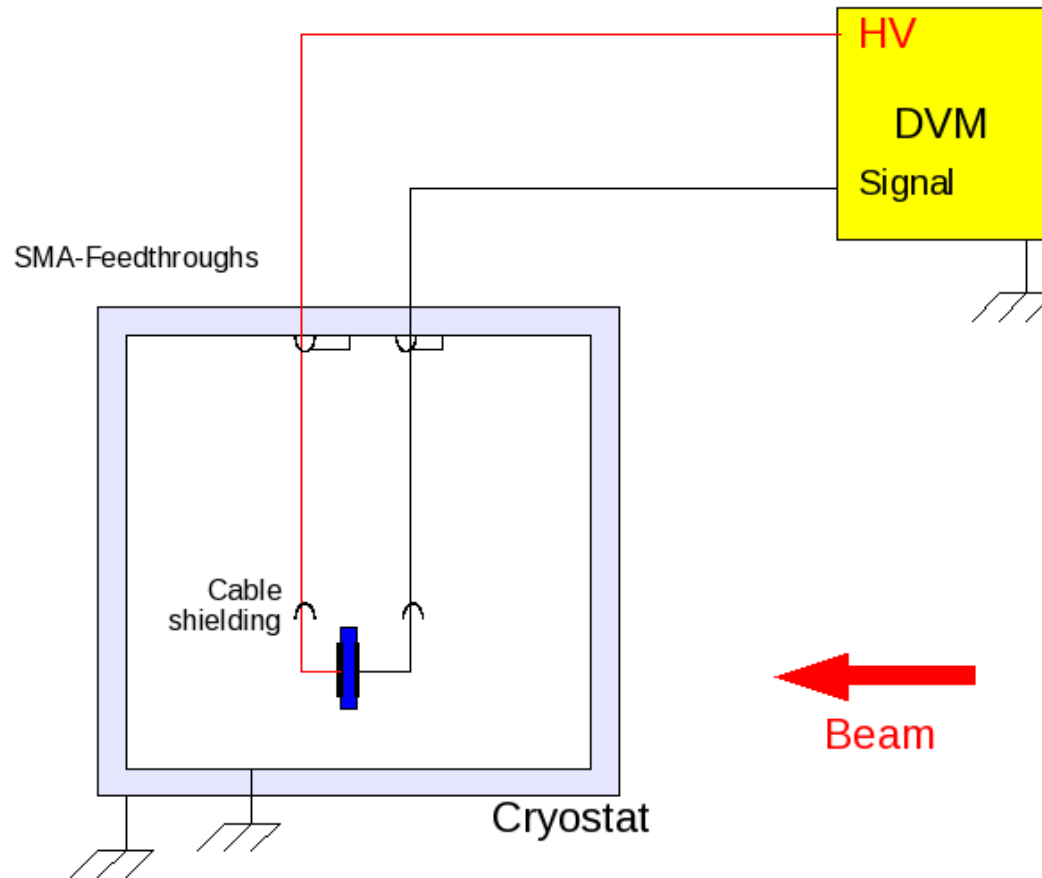
900 V  
Superfluid 1.6 K



- Signal from whole spill
- Ion and electron mobility in superfluid about  $0.02 \text{ cm}^2/\text{V}/\text{s}$  (extremely slow)



# Electronic setup for DC measurements

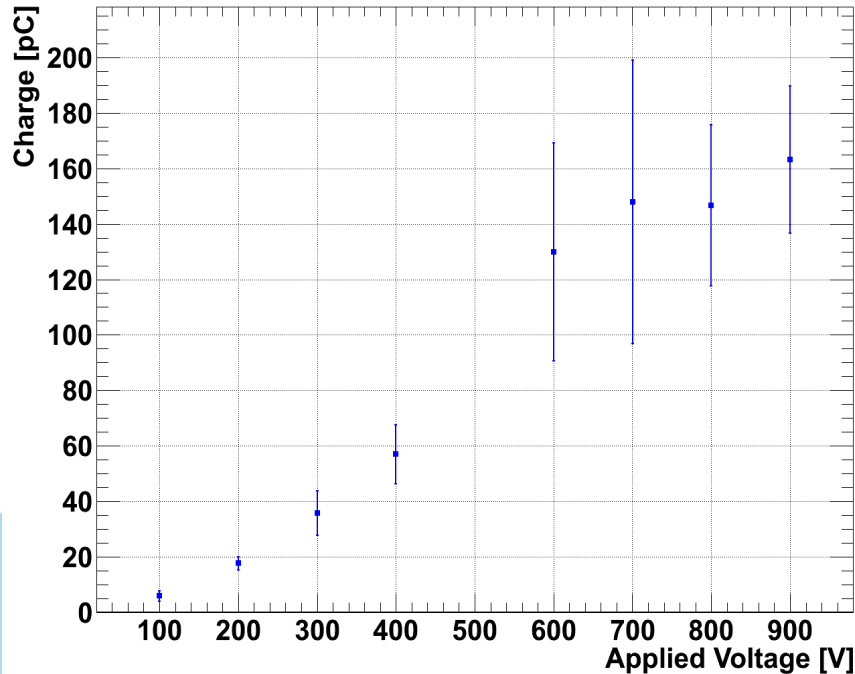




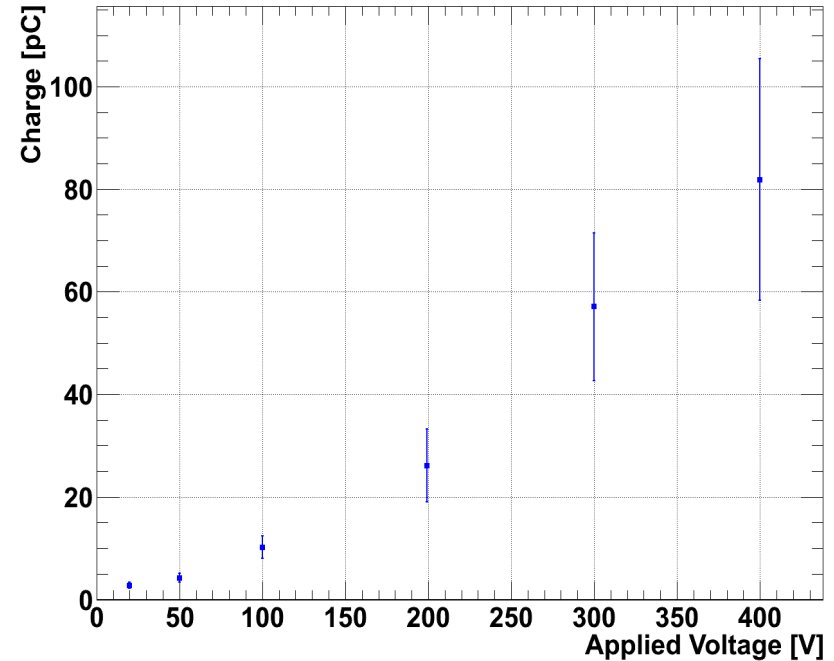


# LHe chamber Collected charge per spill

1.7 K



4.2 K



Above 400 V corona discharge

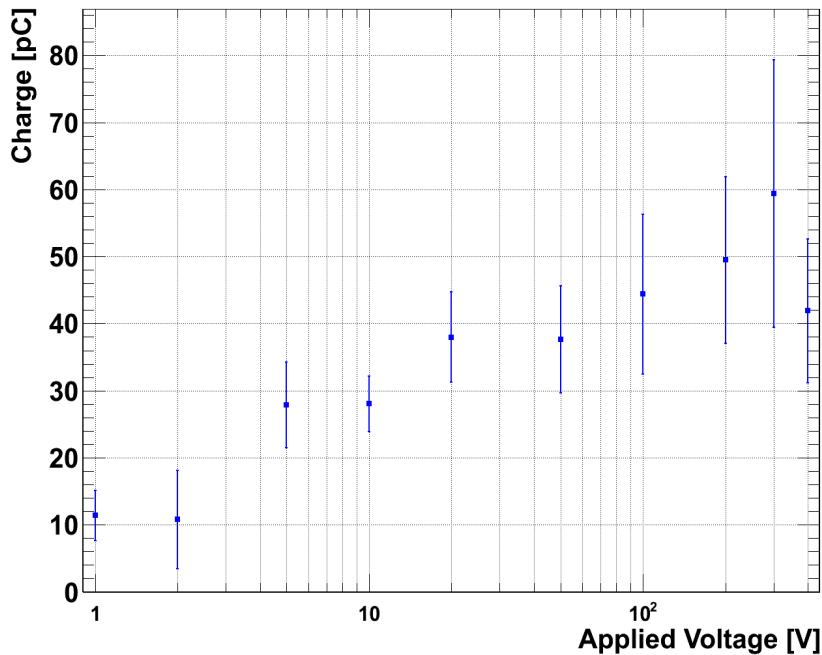
- Estimated charge per spill: 3.66 nC
- Apparently no efficient charge transport, due to slow mobility



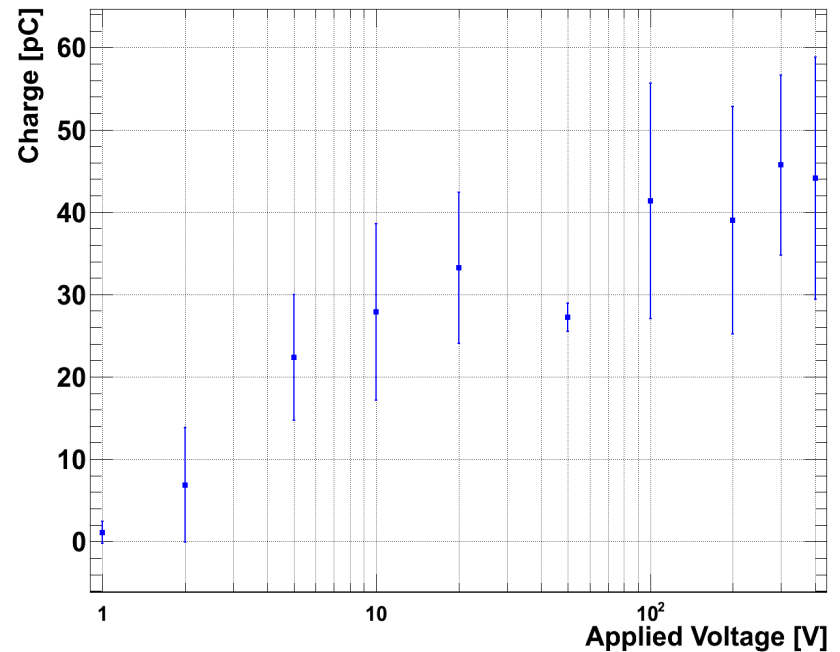
# sCVD

## Collected charge per spill

1.6 K



4.2 K

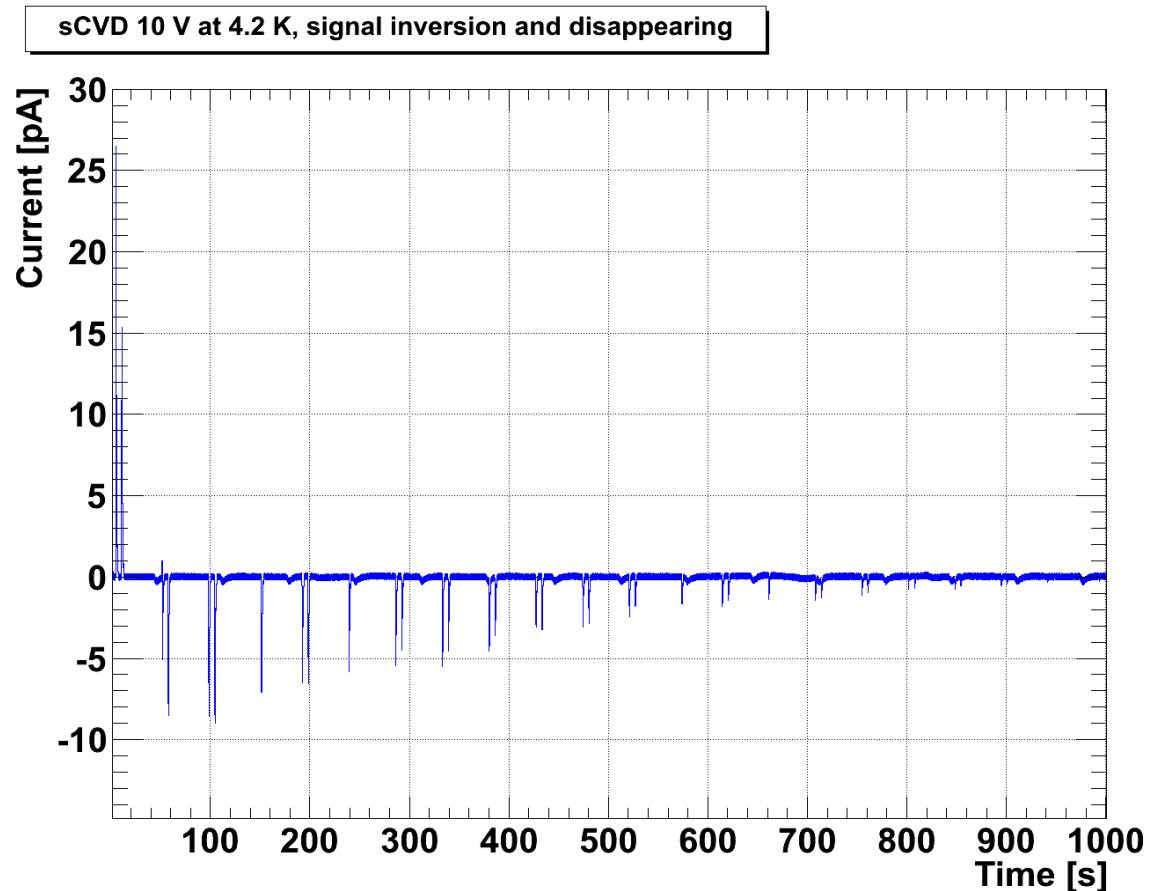


- Estimated charge per spill: 181 pC
- Measured about 45 pC (~ factor 4 less)
- Possible explanation for difference is slight misalignment



# Beam test sCVD signal disappearing

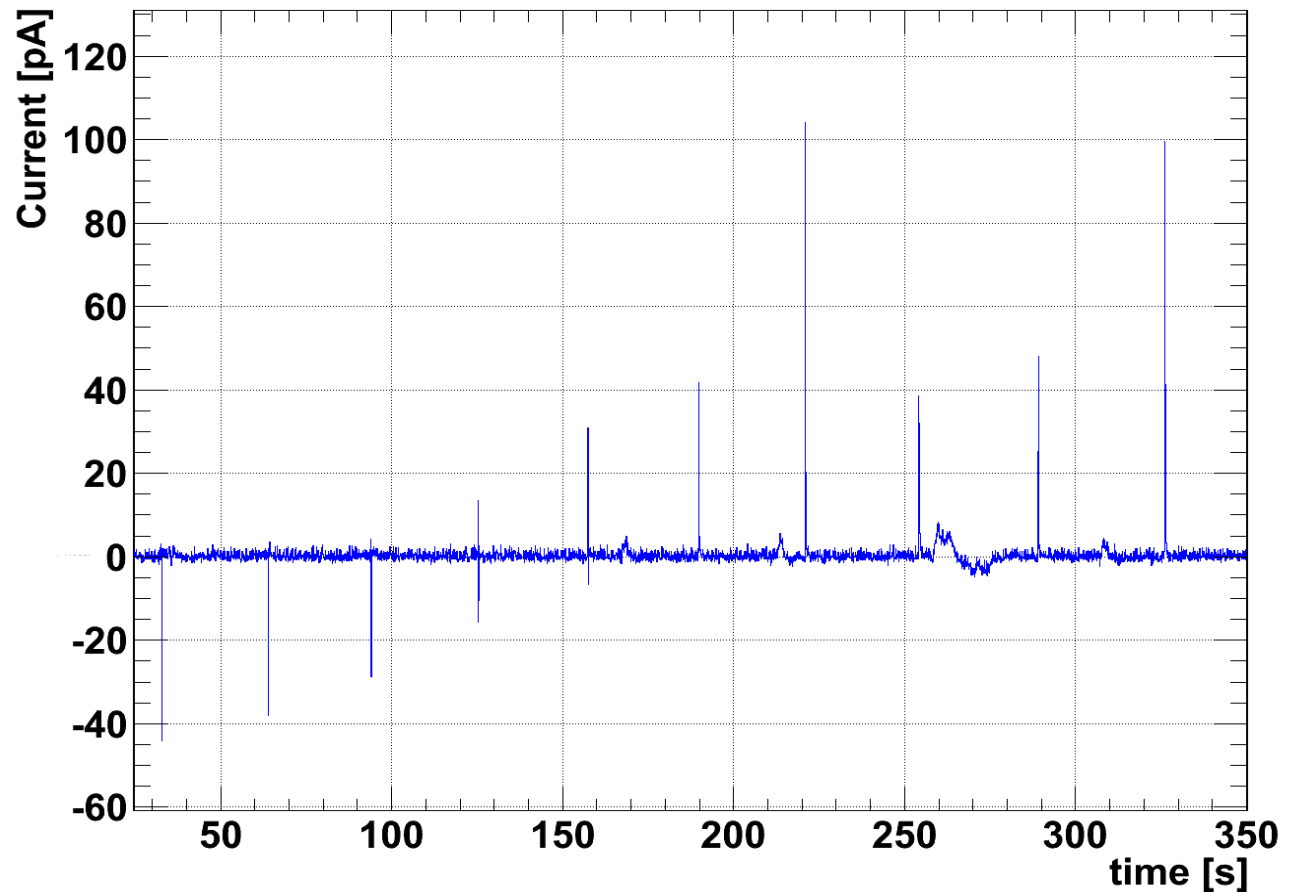
- Signal disappears after about 15 min





# Beam test sCVD signal inversion

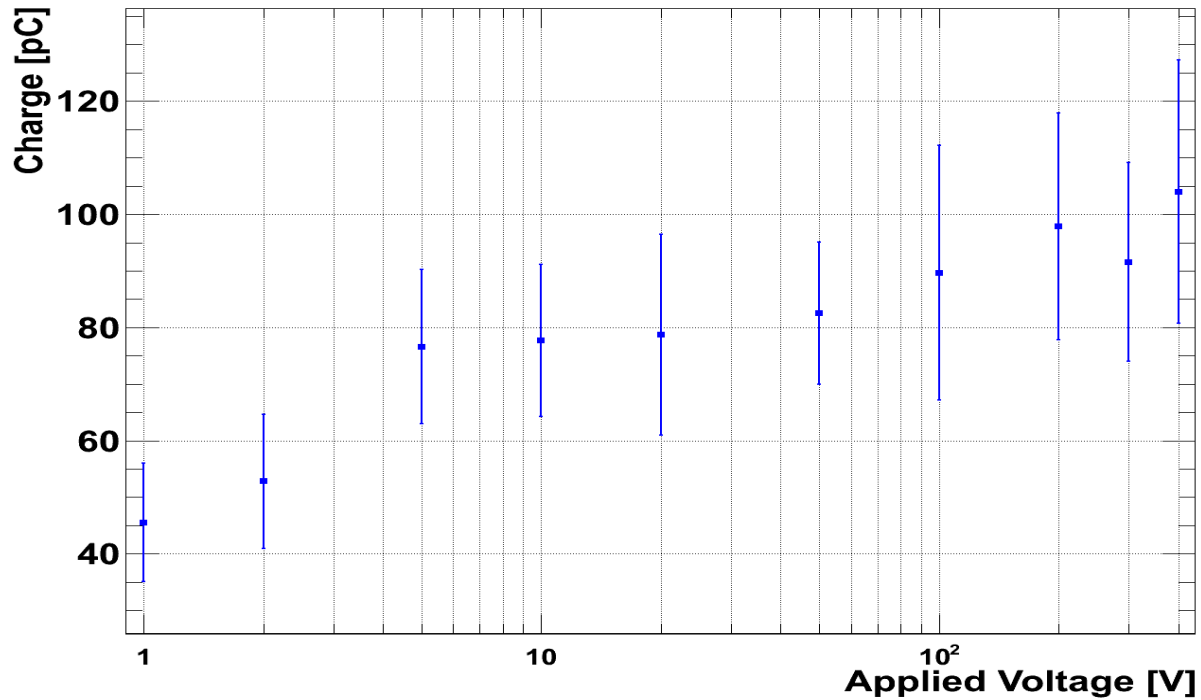
sCVD 10 V at 1.6 K





# Beam test Si collected charge

Si 1.6 K

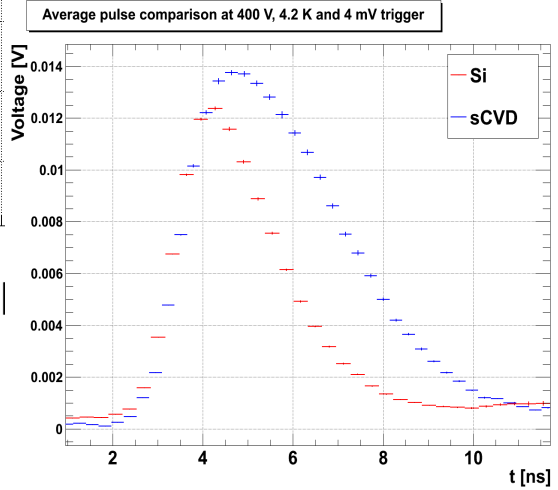
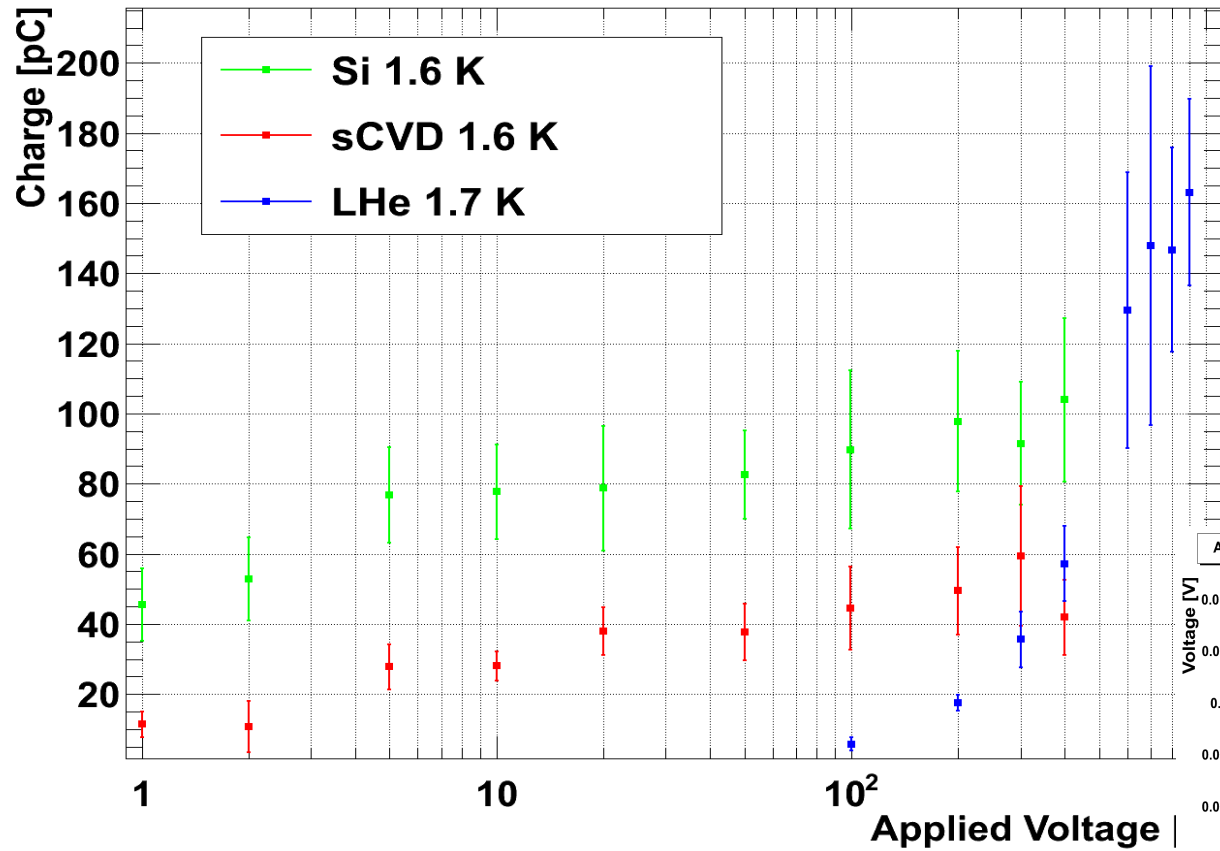


- Estimated charge per spill: 426 pC
- Measured about 100 pC (~ factor 4 less)
- Possible explanation for difference is slight misalignment (factor 4 for Si and sCVD strengthen this hypothesis)



# Charge collection comparison Plots

Charge collection comparison between detectors





# Charge collection comparison Table

- Charge from single particle in fC:

	$Q_{\text{estimated}}$	$\langle Q_{\text{single particle}} \rangle$	$Q_{\text{spill}} / n_{\text{p normalized}}$
LHe	12.2	-	0.49
sCVD	3.79	7.68	0.80
Si	5.68	4.75	1.14

- Remarks:

- Number of particles (normalized to detector size) going through semiconductors not exactly known (misalignment might be major source of disagreement)

- Charge ratio: 
$$\frac{Q_{\text{sCVD estimated}}}{Q_{\text{Si estimated}}} \simeq \frac{Q_{\text{sCVD spill normalized}}}{Q_{\text{Si spill normalized}}}$$

- In single particle measurements some low sCVD pulses might be lost due to trigger setting



## Open questions LHe

- LHe response time (rise immediately?)
- Charge per spill disagreement between estimation and measurement? (No efficient charge transport)
- LHe Ion vs electron mobility, measurable in lab?
- LHe corona discharge, measurable in lab?
- LHe purity inside cryostat? (according to theory should be nothing due to suprafluidity)
- Linearity of response with respect to beam intensity
- Saturation level





# Open questions Semiconductors

- Semiconductors radiation hardness
- Semiconductors leakage current measurable at 1.9 K and 4.2 K?
- Why is charge per particle higher for sCVD than for Si, but not charge per spill?
- Pre-amplifier into the cold?
  - + very low noise
  - - feasible&working in cold with radiation and B-field?
  - - more feed-throughs needed going into cryostat
- Semiconductors polarization at low temperatures (disappearing signal)
- Saturation levels



# Conclusions

- All tested detectors work at superfluid helium temperatures
- Critical missing information:
  - Radiation hardness of semiconductors
  - Time response of LHe chamber
- Ongoing analysis of the beam test data
- In parallel further measurements foreseen in the laboratory:
  - Silicon (TCT) charge generation with laser and alpha source
  - sCVD (TCT) charge generation with alpha source



# Acknowledgements

## Thank you!!!

- **Vladimir Eremin** for semiconductors holder and general help in many ways
- **Thomas Eisel** and his team for cryogenics
- **Jaakko Haerkoenen** for instruments, hints and discussions
- **Erich Griesmayer** for CIVIDEC electronics and many practical hints
- **Ewald Effinger, Jonathan Emery** and **Morad Hamani** for discussions on LHe chamber construction and read out
- **Heinz Pernegger** for analysis program and the sCVD
- **Hendrik Jansen** for material and discussions
- **Werner Riegler** for discussions on LHe chamber results
- **Bernd Dehning** and **Mariusz Sapinski** for continuous support in many ways